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April 1st, 2010 Renesas Electronics Corporation

Issued by: Renesas Electronics Corporation (http://www.renesas.com)

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DATA SHEET

MOS FIELD EFFECT TRANSISTOR NP88N055EHE, NP88N055KHE NP88N055CHE, NP88N055DHE, NP88N055MHE, NP88N055NHE

SWITCHING N-CHANNEL POWER MOS FET

DESCRIPTION

These products are N-channel MOS Field Effect Transistors designed for high current switching applications.

<R> ORDERING INFORMATION

PART NUMBER	LEAD PLATING	PACKING	PACKAGE	
NP88N055EHE-E1-AY Note1, 2			TO-263 (MP-25ZJ) typ. 1.4 g	
NP88N055EHE-E2-AY Note1, 2				
NP88N055KHE-E1-AY Note1	Pure Sn (Tin)	Tape 800 p/reel		
NP88N055KHE-E2-AY Note1			TO-263 (MP-25ZK) typ. 1.5 g	
NP88N055CHE-S12-AZ Note1, 2	Sn-Ag-Cu		TO-220 (MP-25) typ. 1.9 g	
NP88N055DHE-S12-AY Note1, 2			TO-262 (MP-25 Fin Cut) typ. 1.8 g	
NP88N055MHE-S18-AY Note1	Pure Sn (Tin)	Tube 50 p/tube	TO-220 (MP-25K) typ. 1.9 g	
NP88N055NHE-S18-AY Note1			TO-262 (MP-25SK) typ. 1.8 g	

Notes 1. Pb-free (This product does not contain Pb in the external electrode.)

2. Not for new design

FEATURES

- Channel temperature 175 degree rated
- Super low on-state resistance

 $R_{DS(on)} = 5.3 \text{ m}\Omega$ MAX. (VGs = 10 V, ID = 44 A)

• Low input capacitance

Ciss = 7600 pF TYP.

• Built-in gate protection diode





(TO-262)



(TO-263)



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Document No. D14148EJ8V0DS00 (8th edition) Date Published October 2007 NS Printed in Japan

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The revised points can be easily searched by copying an "<R>" in the PDF file and specifying it in the "Find what:" field.

ABSOLUTE MAXIMUM RATINGS (TA = 25°C)

Drain to Source Voltage (VGs = 0 V)	VDSS	55	V
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V
Drain Current (DC) (Tc = 25°C) Note1	D(DC)	±88	А
Drain Current (Pulse) Note2	D(pulse)	±352	А
Total Power Dissipation ($T_A = 25^{\circ}C$)	Pt1	1.8	W
Total Power Dissipation (Tc = 25°C)	Рт2	288	W
Channel Temperature	Tch	175	°C
Storage Temperature	Tstg	–55 to +175	°C
Single Avalanche Current Note3	las	65/88	А
Single Avalanche Energy Note3	Eas	422/15	mJ

Notes 1. Calculated constant current according to MAX. allowable channel temperature.

2. PW \leq 10 μ s, Duty Cycle \leq 1%

3. Starting T_{ch} = 25°C, V_{DD} = 28 V, R_G = 25 Ω , V_{GS} = 20 \rightarrow 0 V (See Figure 4.)

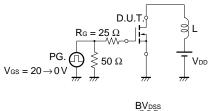
THERMAL RESISTANCE

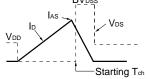
Channel to Case Thermal Resistance	Rth(ch-C)	0.52	°C/W
Channel to Ambient Thermal Resistance	Rth(ch-A)	83.3	°C/W

ELECTRICAL CHARACTERISTICS (T_A = 25°C)

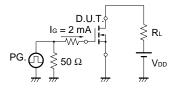
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Zero Gate Voltage Drain Current	Ibss	V _{DS} = 55 V, V _{GS} = 0 V			10	μA
Gate Leakage Current	lgss	V_{GS} = ±20 V, V_{DS} = 0 V			±10	μA
Gate to Source Threshold Voltage	VGS(th)	$V_{DS} = V_{GS}, I_D = 250 \mu A$	2.0	3.0	4.0	V
Forward Transfer Admittance	y _{fs}	V _{DS} = 10 V, I _D = 44 A	30	60		S
Drain to Source On-state Resistance	RDS(on)	V _{GS} = 10 V, I _D = 44 A		4.2	5.3	mΩ
Input Capacitance	Ciss	V _{DS} = 25 V,		7600	11400	pF
Output Capacitance	Coss	V _{GS} = 0 V,		1100	1700	pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		480	870	pF
Turn-on Delay Time	td(on)	V _{DD} = 28 V, I _D = 44 A,		42	93	ns
Rise Time	tr	V _{GS} = 10 V,		26	66	ns
Turn-off Delay Time	td(off)	R _G = 1 Ω		120	240	ns
Fall Time	tr			32	81	ns
Total Gate Charge	QG	V _{DD} = 44 V,		130	200	nC
Gate to Source Charge	QGS	V _{GS} = 10 V,		31		nC
Gate to Drain Charge	Qgd	ID = 88 A		49		nC
Body Diode Forward Voltage	VF(S-D)	IF = 88 A, VGS = 0 V		1.0		V
Reverse Recovery Time	trr	IF = 88 A, VGS = 0 V,		62		ns
Reverse Recovery Charge	Qrr	di/dt = 100 A/µs		120		nC

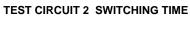
TEST CIRCUIT 1 AVALANCHE CAPABILITY

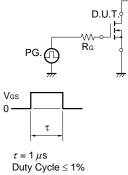


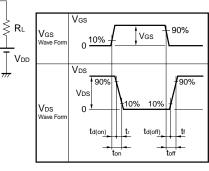


TEST CIRCUIT 3 GATE CHARGE

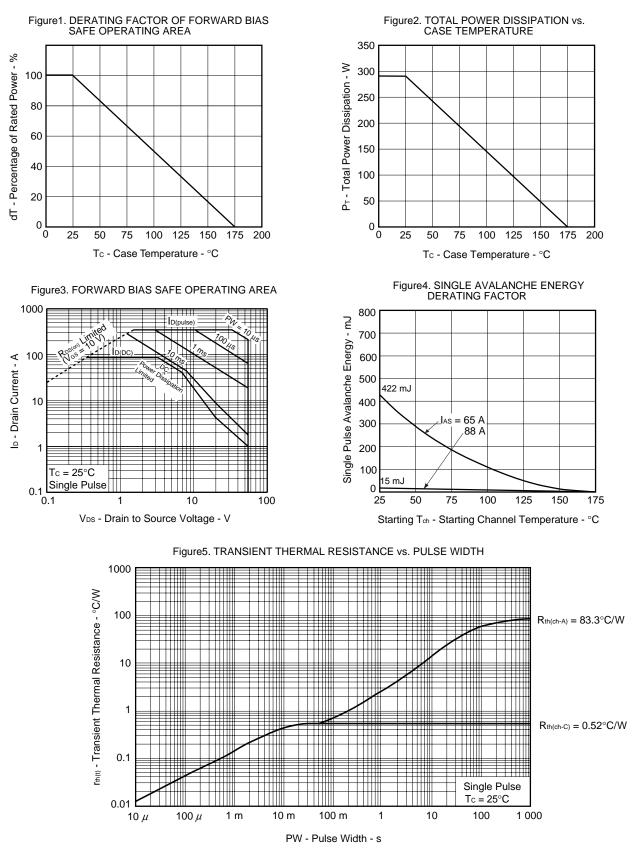






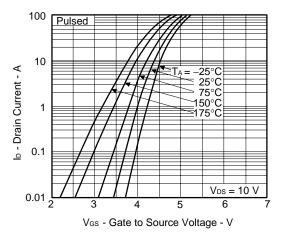


TYPICAL CHARACTERISTICS (TA = 25°C)

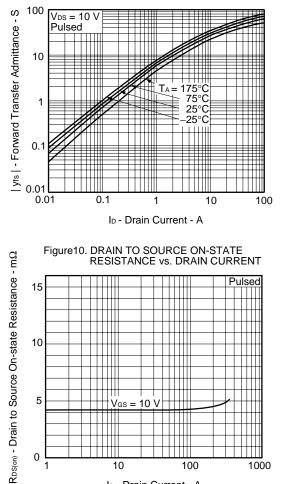


Data Sheet D14148EJ8V0DS

Figure6. FORWARD TRANSFER CHARACTERISTICS







10

0

1

Ш

ID - Drain Current - A

100

1000

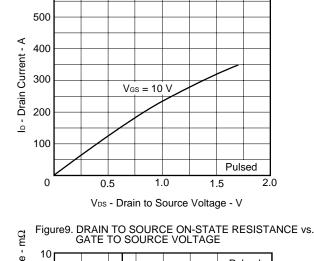


Figure7. DRAIN CURRENT vs. DRAIN TO SOURCE VOLTAGE

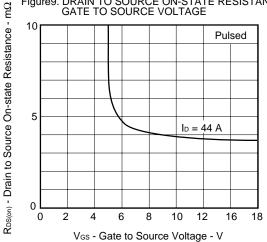
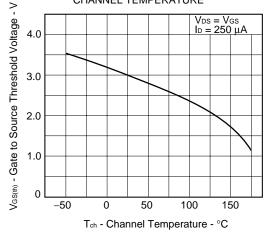
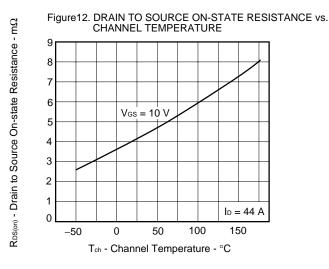


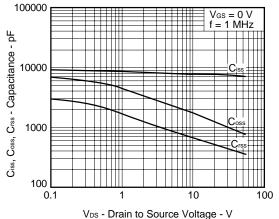
Figure11. GATE TO SOURCE THRESHOLD VOLTAGE vs. CHANNEL TEMPERATURE

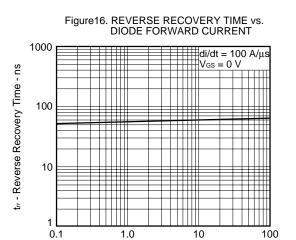


2.0









IF - Diode Forward Current - A

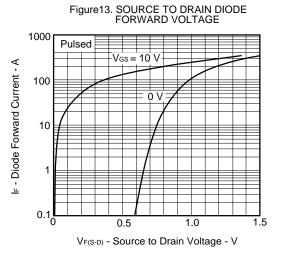


Figure15. SWITCHING CHARACTERISTICS

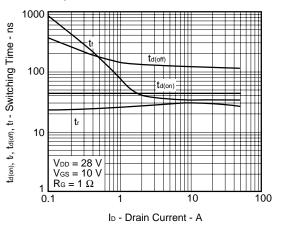
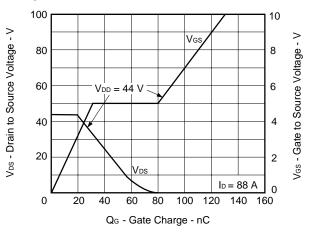
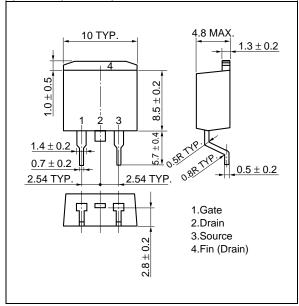


Figure17. DYNAMIC INPUT/OUTPUT CHARACTERISTICS

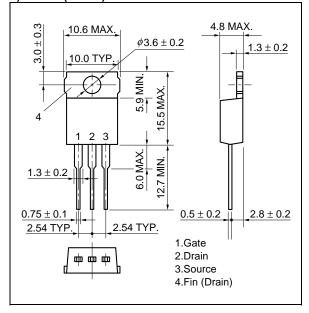


<R> PACKAGE DRAWINGS (Unit: mm)

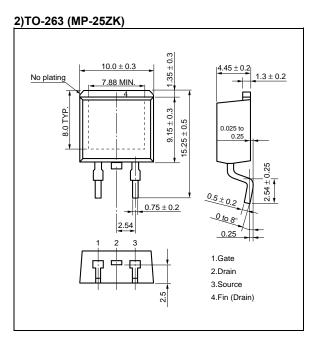
1)TO-263 (MP-25ZJ) Note



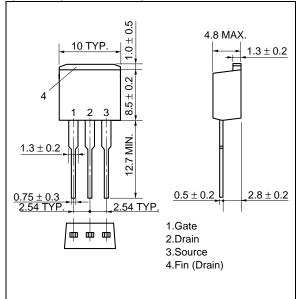
3)TO-220 (MP-25) Note

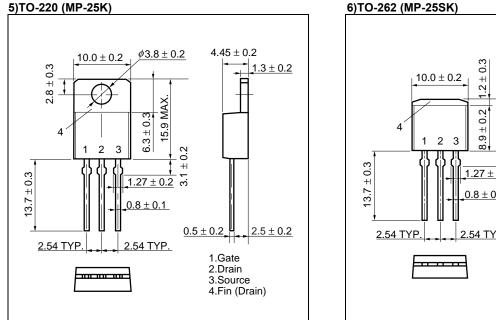


Note Not for new design



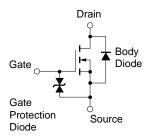
4)TO-262 (MP-25 Fin Cut) Note





$\begin{array}{c} 10.0 \pm 0.2 \\ 1 \\ 2 \\ 3 \\ 1 \\ 2 \\ 2.54 \\ TYP. \\ 2.54 \\ TYP. \\ 2.54 \\ TYP. \\ 1.27$

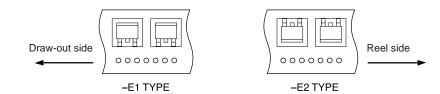
EQUIVALENT CIRCUIT



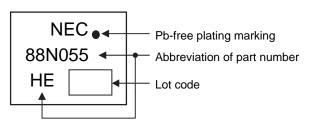
Remark The diode connected between the gate and source of the transistor serves as a protector against ESD. When this device actually used, an additional protection circuit is externally required if a voltage exceeding the rated voltage may be applied to this device.

<R> TAPE INFORMATION

There are two types (-E1, -E2) of taping depending on the direction of the device.



<R> MARKING INFORMATION



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These products should be soldered and mounted under the following recommended conditions.

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For technical information, see the following website.

Semiconductor Device Mount Manual (http://www.necel.com/pkg/en/mount/index.html)

Soldering Method	Soldering Conditions	Recommended Condition Symbol	
Infrared reflow	Maximum temperature (Package's surface temperature): 260°C or below		
MP-25ZJ, MP-25ZK	Time at maximum temperature: 10 seconds or less		
	Time of temperature higher than 220°C: 60 seconds or less		
	Preheating time at 160 to 180°C: 60 to 120 seconds	IR60-00-3	
	Maximum number of reflow processes: 3 times		
	Maximum chlorine content of rosin flux (percentage mass): 0.2% or less		
Wave soldering	Maximum temperature (Solder temperature): 260°C or below		
MP-25, MP-25K, MP-25SK,	Time: 10 seconds or less	THDWS	
MP-25 Fin Cut	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		
Partial heating	Maximum temperature (Pin temperature): 350°C or below		
MP-25ZJ, MP-25ZK,	Time (per side of the device): 3 seconds or less	P350	
MP-25K, MP-25SK	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		
Partial heating	Maximum temperature (Pin temperature): 300°C or below		
MP-25, MP-25 Fin Cut	Time (per side of the device): 3 seconds or less	P300	
	Maximum chlorine content of rosin flux: 0.2% (wt.) or less		

Caution Do not use different soldering methods together (except for partial heating).

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